

## **Series X55X Universal Zero-Insertion-Force DIP Test Socket**

Pins -

## **FEATURES**

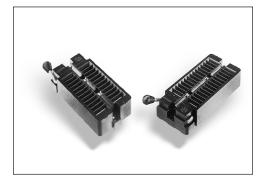
- Aries Universal Test Socket accepts devices on 0.300 to 0.600 [7.62 to 15.24] cen-
- All pin count sockets go into PCB with either 0.300 or 0.600 [7.62 to 15.24] centers.
- Contacts are normally closed to eliminate dependence on plastic to sustain contact.
- Socket handle can be configured with closed contacts (on) when in the UP or DOWN position, and can be mounted on either the right or left side.
- Sockets can be soldered into PCBs or plugged into any socket. Socket fits into Aries' or any competitive test socket receptacle.

## **GENERAL SPECIFICATIONS**

- SOCKET BODY: black UL 94V-0 glass-filled Polyphenylene Sulfide (PPS)
- HANDLE: Stainless Steel
- HANDLE KNOB: Brass 360, 1/2-hard
- CONTACTS: BeCu 172 per QQ-C-533 or BeNi 360 1/2-hard
- CONTACT PLATING: 50μ [1.27μ] min. Ni under-plate per QQ-N-290, over-plated with either 200µ [5.08µ] min. matte Sn per ASTM B545-97 or 200µ [5.08µ] 90/10 Sn/Pb per MIL-T-10727 or 10µ [0.254µ] min. Au per MIL-G-45204
- BeNi CONTACT PLATING: 50μ [1.27μ] min. NiB
- CONTACT CURRENT RATING: 1 amp
- INSULATION RESISTANCE: 1000 m $\Omega$  min.
- DIELECTRIC WITHSTANDING VOLTAGE: 1000 VAC
- LIFE CYCLE: 25.000 to 50.000 cycles
- OPERATING TEMPERATURE: -67°F [-55°C] min.; 221°F [105°C] max. for Sn plating; 302°F [150°C] for Au plating; 392°F [200°C] for NiB plating
- RETENTION FORCE (closed): 55g/pin based on a 0.020 [0.51] dia. test lead
- ACCEPTS LEADS: 0.015-0.045 [0.38-1.14] wide, 0.110-0.280 [2.79-7.11] long

## MOUNTING CONSIDERATIONS

See Socket Footprint below



**CUSTOMIZATION:** In addition to the standard products shown on this page, Aries specializes in custom design and production. Special materials, platings, sizes, and configurations can be furnished, depending on the quantity. **NOTE**: Aries reserves the right to change product general specifications without notice.

**ORDERING INFORMATION** XX-X55X-1 X **Plating** 24, 28, 32, 36, 0 = Sn over Ni40, 42, 44, 48 OTL = Sn/Pb over Ni Row-to-Row Spacing (btm) 1 = Au over Ni3 = 0.300 [7.62]6 = NiB BeNi Contact Only 6 = 0.600 [15.24]Solder Pin Tail

> 1 = Left, up is on 2 = Right, up is on

Handle Options

3 = Left, down is on

4 = Right, down is on (std) **NOTE:** "on" = closed contacts

ALL DIMENSIONS: INCHES [MILLIMETERS]

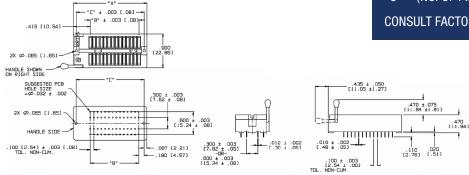
ALL TOLERANCES: ±0.005 [0.13] UNLESS OTHERWISE SPECIFIED

"A" =  $(N0. OF PINS PER ROW \times 0.100 [2.54]) + 0.590 [14.99]$ 

"B" =  $(N0. OF PINS PER ROW -1) \times 0.100 [2.54]$ 

"C" =  $(NO. OF PINS PER ROW \times 0.100 [2.54] + 0.415 [10.54]$ 

CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS





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